

**SMD Ceramic Resonators** 

#### 1. SCOPE

This specification shall cover the characteristics of the ceramic resonator with the type ZTTCE14.56MG.

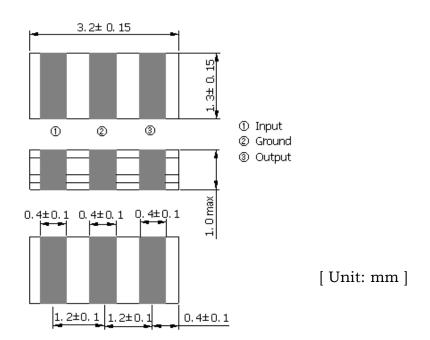
#### 2. PART NO.:

PART NUMBER	CUSTOMER PART NO	SPECIFICATION NO
ZTTCE14.56MG		

#### 3. OUTLINE DRAWING AND DIMENSIONS:

Appearance: No visible damage and dirt.

**Dimensions:** 





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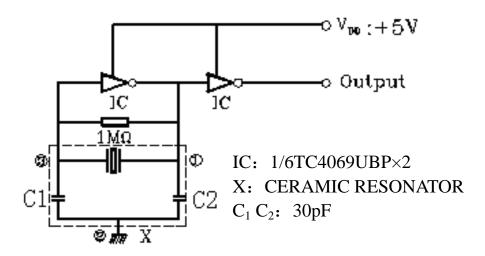
#### 4. ELECTRICAL SPECIFICATIONS:

No	Item	Requirements		
4.1	Oscillation Frequency Fosc (MHz)	14.56		
	Frequency Accuracy (%)	±0.5		
4.2	Resonant Impedance Ro ( $\Omega$ )max	30		
4.3	Temperature Coefficient of	$\pm 0.3$ (Oscillation Frequency		
	Oscillation Frequency (%) max	drift $-20^{\circ}$ C to $+80^{\circ}$ C)		
4.4	Withstanding Voltage	50 VDC, 1 min		
4.5	Rating Voltage U <sub>R</sub> (V)			
	(1) D.C. Voltage	6 VDC.		
	(2) A.C. Voltage	15 Vp-p.		
4.6	Insulation Resistance Ri, $(M \Omega)$ min	100 (100V, 1min)		
4.7	Operating Temperature $(^{\circ}C)$	-40~+85		
4.8	Storage Temperature $(^{\circ}\mathbb{C})$	<b>-55∼+85</b>		
4.9	Aging Rate (%) max	$\pm 0.3$ (For 10 years)		

#### 5. MEASUREMENT:

Measurement Conditions: Parts shall be measured under a condition ( Temp.:  $20\pm15$  °C ,Humidity :  $65\pm20\%$  R.H.) unless the standard condition(Temp.:  $25\pm3$  °C ,Humidity :  $65\pm5\%$  R.H.) is regulated to measure.

Test Circuit:





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## 6. PHYSICAL AND ENVIRONMENTAL CHARACTERISTICS

No	Item	Condition of Test		Performance			
				Requirements			
6.1	Humidity	Keep the resonator at 40±2℃ and 90	It shall fulfill				
		for 96±4 hours. Then Release the reso	onator into	the			
		the room Condition for 1 hour pri	ior to the	specifications			
		Measurement.		in Table 1.			
6.2	Vibration	Subject the resonator to vibration for	or 2 hours	It shall fulfill			
		each in x, y and z axis With the am	plitude of	the			
		1.5mm, the frequency shall be varied	uniformly	specifications			
		between the limits of 10 Hz—55Hz.		in Table 1.			
6.3	Mechanical	Drop the resonator randomly onto	a wooden	It shall fulfill			
	Shock	floor from the height of 100cm 3 time	es.	the			
				specifications			
				in Table 1.			
6.4	Soldering	Passed through the re-flow oven	under the	It shall fulfill			
	Test	following condition and left	at room	the			
		temperature for 1 hour before measure	ement.	specifications			
		Temperature at the surface of the	Time	in Table 1.			
		substrate					
		Preheat 150±5°C	60±10				
			sec				
		Peak 240±5°C	10±3 sec				
6.5	Solder	Dipped in 230±5°C solder bath for	3±0.5 sec	The terminals			
	Ability	seconds with rosin flux (25wt%	ethanol	shall be at			
		solution.)		least 95%			
				covered by			
				solder.			
6.6	High	Subject the resonator to 80±5°C for	96 hours,	It shall fulfill			
	Temperature	then release the resonator into	the room	the			
	Exposure	conditions for 1 hour prior to the mea	surement.	specifications			
				in Table 1.			
6.7	Low	Subject the resonator to -20±5°C for	96 hours,	It shall fulfill			
	Temperature	then release the resonator into	the room	the			
	Exposure	conditions for 1 hour prior to the mea	surement.	specifications			
				in Table 1.			



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#### 6. PHYSICAL AND ENVIRONMENAL CHARACTERISICS

(Continued from the preceding page)

N.T.	т,	D C	
No	Item	Condition of Test	Performance
			Requirements
6.8	Temperature	Subject the resonator to -40°C for 30	It shall fulfill the
	Cycling	min. followed by a high temperature of	specifications in
		85°C for 30 min.	Table 1.
		Cycling shall be repeated 5 times with a	
		transfer time of 15 sec. At the room	
		temperature for 1 hour prior to the	
		measurement.	
6.9	Board	Mount a glass-epoxy board	Mechanical damage
	Bending	(Width=40mm,thickness=1.6mm),then bend it	such as breaks shall
		to 1mm displacement and keep it for 5 seconds.	not occur.
		(See the following figure)	
		Π	
		PRESS	
		20	
		PRESS HEAD	
		810	
		D.U.T. of	
		1.01	
		45±2 45±2	
		Ø5 SUPPORT BAR	
		1	

#### TABLE 1

Item	Specification		
Oscillation Frequency Change  △Fosc/Fosc (%) max	±0.3		
Resonant Impedance Change $\triangle \text{Ro}(\Omega)$ max	±10		

Note: The limits in the above table are referenced to the initial measurements.



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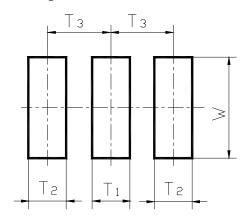
#### 7. REVIEW OF SPECIFICATIONS

When something gets doubtful with this specifications, we shall jointly work to get an agreement.

#### 8. RECOMMENDED LAND PATTERN AND REFLOW SOLDERING

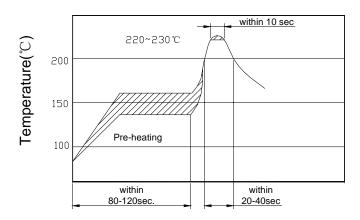
#### STANDARD CONDITIONS

## 8.1Recommended land pattern



DIMENSIONS (mm)							
$egin{array}{ c c c c c c c c c c c c c c c c c c c$							
0.4±0.2	$0.4\pm0.1$	1.2±0.1	1.3±0.15				

## 8.2Recommended reflow soldering standard conditions





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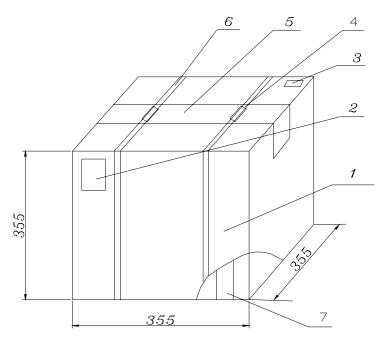
#### 9. PACKAGE

To protect the products in storage and transportation, it is necessary to pack them (outer and inner package). On paper pack, the following requirements are requested.

#### Dimensions and Mark

At the end of package, the warning (moisture proof, upward put) should be stick to it.

Dimensions and Mark (see below)



NO.	Name	Quantity	Notes
1	Package	1	
2	Certificate of approval	1	
3	Label	1	
4	Tying	2	
5	Adhesive tape	1.2m	
6	Belt	2.9m	
7	Inner Box	10	



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#### Section of package

Package is made of corrugated paper with thickness of 0.8cm.Package has 10 inner boxes, each box has 1 reel(each reel for plastic bag)

#### Quantity of package

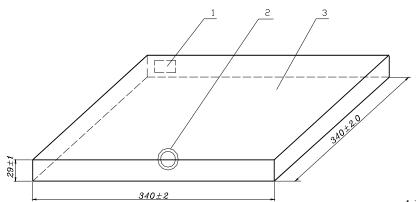
Per plastic reel 4000 pieces of piezoelectric ceramic part

Per inner box 1 reel

Per package 10 inner boxes (40000 pieces of piezoelectric

ceramic part )

#### **Inner Packing Dimensions**



1.UNIT: mm

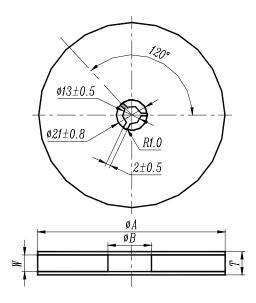
1	Label			
2	QC Label			
3	Inner Box			

Pars shall be packaged in box with hold down tape upside. Part No., quantity and lot No.



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8.5Reel

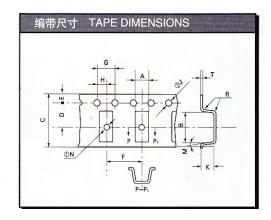


Dimensions Unit: mm

ΦА	φВ	W	T	Pieces per reel	Carrier tape size		
330±3	80min	16.4min	22.4max	4000typ.	16		

# 8.6Taping Dimensions

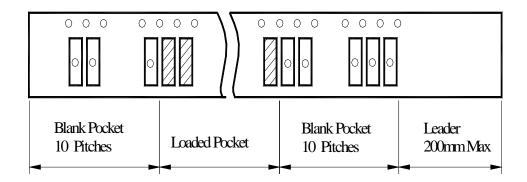
尺寸 标记 允差 Code 型 号 Tolerance Part Number	A ±0.2	B ±0.2	C ±0.3	D ±0.1	E ±0.1	F ±0.1	<b>G</b> ±0.1	H ±0.1	ØJ ±0.1	Ø <b>N</b> ±0.1	M max	R max	<b>K</b> ±0.2	T ±0.1
<del>ZTA</del> SS⊟MG	3.8	7.8	16.0	7.5	1.75	8.0	4.0	2.0	1.5	1.6	10°	0.3	2.1	0.3
ZTACR⊟MG ZTTCR⊟MG	2.2	4.7	12.0	5.5	1.75	4.0	4.0	2.0	1.6	1.6	3°	0.3	1.3	0.3
ZTTCE□MG	1.5	3.4	8.0	3.5	1.75	4.0	4.0	2.0	1.6	1.1	3°	0.3	1.3	0.2
ZTACS MT/MX	5.0	4.4	12.0	5.5	1.75	8.0	4.0	2.0	1.5	1.6	10°	0.3	1.8	0.3
<del>ZT1</del> 8V∃MT/MX	3.4	4.0	12.0	5.5	1.75	8.0	4.0	2.0	1.5	1.6	10°	0.3	1.3	0.3
ZTACW⊟MX ZTTCW⊟MX	2.2	2.8	8.0	3.5	1.75	4.0	4.0	2.0	1.6	1.1	3°	0.3	1.3	0.2





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## 8.7Packing Method Sketch Map



## 8.8Test Condition Of Peeling Strength

